



#### FEATURES

- CW operation with external driver transistor
- ♦ 3 to 24 V power supply
- Analog modulation frequency of up to 50 kHz
- Internal programmable logarithmic monitor resistor
- Operating point setup with a logarithmic resolution of 10 bits
- Current or power control mode (ACC/APC) configurable
- A/D converters for analog signals monitoring
- Serial programming interface (SPI or I<sup>2</sup>C compliant)
- Configuration RAM content integrity monitoring
- Optimized for both N-type and P-type laser diodes
- Low drop linear regulator for 3.3 V
- Low current standby mode
- Temperature monitor
- Temperature range of -40 to 85 °C

# APPLICATIONS

- ♦ Commercial LED/Laser diode
- modules Safety related CW laser diode
- drivers
- Structured-light 3D illumination
- ♦ Laser diode stack control
- Optical amplification
- Optical pumping

#### PACKAGES



QFN24 4 mm x 4 mm



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#### DESCRIPTION

The CW power laser diode driver iC-HTG can operate a laser diode or LED with an external power transistor and features automatic current (ACC) and power (APC) control. All parameters, including the internal reference voltages, are set via serial communication (I<sup>2</sup>C or SPI). A 10-bit D/A converter with logarithmic or linear characteristic is used to set the operating point. This allows an operating point resolution better than 1%. In APC mode, the monitor diode photocurrent is used to track the optically emitted power of the laser diode. The voltage across the resistor through which the photocurrent flows is used for feedback in the control loop. An internal 8-bit programmable logarithmic monitor resistor (PLR) or an external monitor resistor can be selected to close the control loop. The PLR ranges from  $100 \Omega$  to  $407 k\Omega$  with a step width of less than 5%. In ACC mode, the laser diode current can be measured by means of a low impedance shunt resistor. The output power can be analog modulated with a frequency of up to 50 kHz. iC-HTG allows the laser channel to be disabled when an overcurrent threshold has been exceeded. The overcurrent threshold is programmable using an 8-bit linear D/A converter. The temperature monitor measures the internal chip temperature. iC-HTG disables the laser channel when

overtemperature is detected. A number of voltages can be measured with a 10-bit A/D converter:

• V(VB)

- V(VBL)
- V(VDD)
- V(ANIN)
- V(MC)
- V(MDL)
- V(VRP)
- V(VRN)

The current output pin DCO can be used to adjust an external DC/DC converter. Controlling the DC/DC output voltage may optimize the power dissipation of the whole system to extend battery life, for example. In standby mode iC-HTG has a very low current consumption (typ. < 10  $\mu$ A) while retaining its configuration. The device features for **safe operation** are:

- · Configuration RAM content integrity monitored
- Tri-state configuration pins
- · Write protection in operating mode
- · Safe power-up state

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#### PACKAGING INFORMATION QFN24 4 mm x 4 mm to JEDEC

PIN CONFIGURATION QFN24 4 mm x 4 mm (topview)



PIN	FUNCTIONS	8
No.	Name	Function
1	NCHK	Check output, active low
2	NSTBY	Standby input, active low
3	NCS/A1	Chip Select, active low / I <sup>2</sup> C Ad- dress bit 1
4	ID	I <sup>2</sup> C address bit 2
5	EC	Enable Channel input
6	MOSI/A0	SPI Master Out Slave In / I <sup>2</sup> C Ad- dress Bit 0
7	SCLK/SCL	SPI Clock / I <sup>2</sup> C Clock
8	MISO/SDA	SPI Master In Slave OUT / I <sup>2</sup> C Data
9	ANIN	Analog input for ADC
10	MCH	Current monitor high side
11	MCL	Current monitor low side
12	MOD	Analog modulation
13	CI	Integration Capacitor high side
14	CIL	Integration Capacitor low side
15	VRN	N transistor control
16	VRP	P transistor control
17	VBL	Channel supply
18	MD	Monitor diode
19	MR	Monitor resistor
20	GND	Ground
21	DCO	DC/DC converter trimmer
22	INS	I <sup>2</sup> C or SPI selection input
23	VDD	3.3 V output supply
24	VB	Power supply
	BP(TP)	Backside Paddle (GND) 1)

IC top marking: <P-CODE> = product code, <A-CODE> = assembly code (subject to changes). 1) Connecting the backside paddle is recommended by a single link to GND. A current flow across the paddle is not permissible.

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#### PACKAGE DIMENSIONS QFN24-4x4

All dimensions given in mm. This package falls within JEDEC MO-220-VHHD-1.









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#### ABSOLUTE MAXIMUM RATINGS

These ratings do not imply permissible operating conditions; functional operation is not guaranteed. Exceeding these ratings may damage the device.

Item	Symbol	Parameter	Conditions			Unit
No.	-			Min.	Max.	
G001	VB	Voltage at VB, VBL		-0.3	30	V
G002	I(VB)	Current in VB, VBL		-20	50	mA
G003	VDD	Voltage at VDD		-0.3	5.5	V
G004	I(VDD)	Current in VDD		-20	1	mA
G005	V()	Voltage at DCO, ANIN, SCLK/SCL, MISO/SDA, MOSI/A0, NCS/A1, DCO, INS, NCHK, CI, MOD, EC		-0.3	5.5	V
G006	V()	Voltage at VRP, VRN, MCH, MCL, NSTBY			30	V
G007	I()	Current in DCO, ANIN, SCLK/SCL, MISO/SDA, MOSI/A0, NCS/A1, DCO, INS, NCHK, CI, VRP, VRN, MCH, MCL NSTBY, EC		-20	20	mA
G008	V()	Voltage at CIL		-0.3	0.5	V
G009	I(CIL)	Current in CIL	DC current	-900	1	mA
G010	Vd()	ESD Susceptibility at all pins	HBM 100 pF discharged through $1.5 \text{ k}\Omega$ CDM (JEDEC Standard No. 22-C101F)		2 0.5	kV kV
G011	Tj	Operating Junction Temperature		-40	85	°C
G012	Ts	Storage Temperature Range		-40	150	°C

#### THERMAL DATA

Operating Conditions: VB = 3 24 V (referenced to GND)							
ltem	Symbol	Parameter	Conditions				Unit
No.	-			Min.	Тур.	Max.	
T01	Та	Operating Ambient Temperature Range		-40		85	°C
T02	Rthja	Thermal Resistance Chip/Ambient	Mounted on PCB		25		K/W
T03	RthjTP	Thermal Resistance Chip/Thermal Pad			4		K/W

All voltages are referenced to ground unless otherwise stated. All currents flowing into the device pins are positive; all currents flowing out of the device pins are negative.

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#### ELECTRICAL CHARACTERISTICS

tem	Symbol	Parameter	Conditions				Unit
No.				Min.	Тур.	Max.	
	onality and p	parameters beyond the operating ndividual application using FMEA	conditions (with reference to independent volt methods.	age supplie	es, for in	stance) a	ire to b
001	VB	Permissible Supply Voltage	Relative to GND	3		24	V
002	I(VB)	Standby Current at VB				10 30	μΑ μΑ
003	I(VBL)	Standby Current at VBL	$\begin{array}{l} V(NSTBY) \leq 0.4 \ V; \\ VBL = 311 \ V \\ VBL = 1124 \ V \end{array}$			10 25	μΑ μΑ
004	I(VB)	Supply Current at VB	No load, EC, NSTBY = hi			5	mA
005	I(VBL)	Supply Current at VBL	No load, EC, NSTBY = hi			25	mA
006	V(VB)on	Turn-off threshold at VBL	Increasing VBL	1		2.9	V
007	V(VB)off	Turn-off threshold at VB, VBL	Decreasing VB, VBL	0.8		2.6	V
008	V(VBL)Hys	Power-on hysteresis at VBL		20		500	mV
009		Turn-on threshold	Increasing VDD	1.3		2.4	V
010	· · /	Turn-off threshold	Decreasing VDD	1.2		2.3	V
011	( )	Power-on hysteresis		20		250	mV
012		RAM memory reset during Standby	NSTBY = Io		1.4*		V
013	RCIL()	Resistor between GND and CIL				20	Ω
014	Vc()lo	Clamp Voltage Io at VB, VBL, VDD, NCHK, NCS/A1, MISO/SDA, MOSI/A0, SCLK/SCL, INS, NSTBY, EC, DCO, CI, MD, MR, MCH, MCL, VRP, VRN, MOD	l() = -10 mA	-1.6		-0.3	V
Transi	stor Driver	VRx, Clx, MCx, MR, MD					
101	C(CI)	Required capacitor at CI	CW Analog Modulation	1000	80		pF pF
102	I(CI)	Charge Current at Cl	V(CI) = 0 V, CI regulated	-30		-5	μA
103	V(MCx)	Permissible Voltage at MCH, MCL	EC = hi, NSTBY = hi; MCVR = lo MCVR = hi	0 VBL - 5		0.8 VBL	v v
104	V(MR,MD)	Permissible Voltage at MR, MD	EC = hi, NSTBY = hi; EPNNP = lo EPNNP = hi	0 VDD - 1.2		1.2 VDD	v v
105	I(VRP)hi	VRP Current High	VBL = 38 V, VRP = 0 V VBL = 824 V, VRP = VBL - 8 V			-0.25 -1	mA mA
106	I(VRP)lo	VRP Current low	VBL = 35 V, VRP = VBL VBL = 524 V, VRP = 8 V	10 40			mA mA
107	I(VRN)Hi	VRN current High	VRNHR = 1, VBL = 38 V, VRN = 0 V VRNHR = 1, VBL = 824 V, VRN = 0 V VRNHR = 0, VBL = 4.58 V, VRN = 0 V VRNHR = 0, VBL = 824 V, VRN = 10 V			-0.25 -1 -10 -40	mA mA mA mA
108	I(VRN)lo	VRN current Low	VRNHR = 1, VBL = 38 V, VRN = VBL VRNHR = 1, VBL = 824 V, VRN = 5V VRNHR = 0, VBL = 38 V, VRN = VBL VRNHR = 0, VBL = 824 V, VRN = 8V	10 30 10 40			mA mA mA mA
109	V(VRP)	Voltage output range	No load, channel enabled; VBL = 3V VBL = 9V VBL = 15V VBL = 15V VBL = 24V	1.9 3 3.5 4.5		3 9 15 24	

\* Projected value by sample characterization

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#### ELECTRICAL CHARACTERISTICS

Item	Symbol	Parameter	Conditions	Min	Turn	Max	Unit
No.				Min.	Тур.	Max.	<b> </b>
110	V(VRN)	Voltage output range	No load, channel enabled;	0		1	v
			VRNHR = Io, VBL = 3 V VRNHR = Io, VBL = 9 V	0		6.5	v
			VRNHR = Io, VBL = 15 V	Ő		12	v
			VRNHR = IO, VBL = 24 V	ŏ		19	v
			VRNHR = hi, VBL = 3 V	1.8		3	V
			VRNHR = hi, VBL = 9 V	2.3		9	V
			VRNHR = hi, VBL = 15 V	3.1		15	V
			VRNHR = hi, VBL = 24 V	4		24	V
111	Ten	Time to laser enabled	NSTBY Io $\rightarrow$ hi, no load at VDD, V(VDD) 0 to 90 %, CVDD = 1 $\mu$ F		1.3		ms
Progra	ammable Re	esistor					
201	Rmda	Resistor at MD and MR pin	RMD(7:0) = 0xFF, DISP = 0	350	500	650	kΩ
			RMD(7:0) = 0x00, DISP = 0	0.154	0.220	0.286	kΩ
202	Tk	Temperature coefficient			-500		ppm/K
203	ΔR	Resistor increment	$\Delta R = \frac{R(n+1) - R(n)}{R(n)}$	1	3.3	7	%
204	lleak(MDA)	MD, MR leakage current	DISP = 1	-2		2	μA
D/A Co	onverter				<u>.</u>		
301	RES(DAC)	D/A Converter Resolution				10	bit
302	ΔV	Voltage increments	LINLOG = 0, $\Delta V = \frac{V(n+1)-V(n)}{V(n)}$	0.05	0.235	1	%
303	ΔV	Voltage increments	LINLOG = 1	1	1		mV
304	V(DAC)	D/A Converter	LINLOG = 0/1;	1			1
			REF(9:0) = 0x000 lowest value	0.09	0.10	0.12	V
			REF(9:0) = 0x3FF highest value	1.00	1.10	1.25	V
305	V(REF)	D/A Converter	V(MOD) = 1.1 V, analog modulation enabled,				
			LINLOG = 0/1;				
			REF(9:0) = 0x000 lowest value	0.09	0.10	0.12	
			REF(9:0) = 0x3FF highest value	1.00	1.10	1.25	
306	G()	Gain Factor	ACC mode;	4.5		0.5	
			CGAIN(1:0) = 00 CGAIN(1:0) = 01	1.5 3	25	2.5 7.9	
			CGAIN(1:0) = 01 CGAIN(1:0) = 10	6.1	10	15.9	
			CGAIN(1:0) = 11	35	50	70	
Check	Output NC	нк	I				
401	Vs()lo	Saturation Voltage lo at NCHK	I(NCHK) = 1.0 mA	1		0.4	V
402	lsc()lo	Short Circuit Current lo at NCHK	V(NCHK) = 0.4 3.3 V	3		33	mA
403	llk()	Leakage Current at NCHK	NCHK = 1, V(NCHK) = 0 5.5 V	-10		10	μA
Series	Regulator	Output VDD		II.			
501	V(VDD)	Regulated output voltage	I(VDD) = -10 0 mA, NSTBY = hi	3		3.5	V
502	V(VB,VDD)	Voltage Drop between VB and VDD	VB = 3 V, I(VDD) = -10 0 mA, NSTBY = hi		300	690	mV
503	C(VDD)	Capacitor at VDD	Ri(C) < 1 Ω	1		3.3	μF
504	Tvdd	Settling time VDD	NSTBY Io $\rightarrow$ hi, no load at VDD,	1		1	ms
			V(VDD) 0 to 90 %, CVDD = 1 µF	<u> </u>			
505	Isc(VDD)	Short circuit current at VDD	VDD Connected to GND	-125			mA
-			0, SCLK/SCL, ID, NSTBY, EC, ANIN	1			
601	Vt()hi	Input Threshold Voltage hi at NCS/A1, MISO/SDA, MOSI/A0, SCLK/SCL, ID, NSTBY, EC, ANIN	MISO/SDA as input with INS = hi			2	V
602	Vt()lo	Input Threshold Voltage Io at NCS/A1, MISO/SDA, MOSI/A0, SCLK/SCL, ID, NSTBY, ANIN, EC, ANIN	MISO/SDA as input with INS = hi	0.8			V

05/24 / V3 / MaH4F / ichaus/ic-htg-laser-diode-driver

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#### ELECTRICAL CHARACTERISTICS

ltem	Symbol	Parameter	Conditions	Min.	- T	Marr	Unit
No.					Тур.	Max.	
603	Vt()hys	Hysteresis at NCS/A1, MISO/SDA, MOSI/A0, SCLK/SCL, ID, NSTBY, ANIN, EC	Vt()hys = Vt()hi — Vt()lo	50			mV
604	lpd()	Pull-Down Current at MOSI/A0, EC	V() = 0.4 V VDD	1		50	μA
605	lpd()	Dynamic Pull-Down Current at NSTBY	V() = 0.4 V Vt()lo V() = Vt(hi) VB	1 0.5		50 15	μΑ μΑ
606	Rpu()	Pull-Up Resistor at NCS/A1, SCLK/SCL		80	150	260	kΩ
607	Rpu()	Pull-Up Resistor at MISO/SDA	INS = lo INS = hi	8 53	20 100	50 174	kΩ kΩ
608	Er()	Safe enable threshold voltage at INS	Rising Falling	52 30	54 32	56 34	% VDD % VDD
609	Voc()	Open Circuit Voltage at INS		40	41	45	% VDD
610	Ri()	Internal Resistance at INS		170	250	360	kΩ
611	lsc()lo	Short Circuit current lo at MISO/SDA	INS = Io, V(MISO/SDA) = 5.5 V	-40		-4	mA
612	Vs()lo	Saturation Voltage lo at MISO/SDA	INS = Io, I(MISO/SDA) = 2 mA			0.4	V
613	lsc()lo	Short Circuit current lo at ANIN	ANIN as output, V(ANIN) = 5.5 V	-40		-4	mA
614	Vs()lo	Saturation Voltage lo at ANIN	ANIN as output, I(ANIN) = 2 mA			0.4	V
A/D C	onverter						
701	Ton	Converter initialization time	ENAD changes from 0 to 1			500	μs
702	Tconv	Conversion time	ENAD 0→1 to DRDY 0→1			140	μs
703	RES(ADC)	A/D Converter Resolution				10	bit
704	RAC	Relative Accuracy		-1		+1	LSB
705	VZS()	Zero Scale Voltage	ADC(9:0) = 0x000		0		V
706	VFS()	Full Scale Voltage	ADC(9:0) = 0x3FF	1.0	1.1	1.2	V
707	VDDM()	VDD Measurement	VDD = 3.3 V, ADCC(2:0) = 000, ENADCDIV = 1	334	368	402	LSB
708	VBLM()	VBL Measurement	VBL = 24 V, ADCC(2:0) = 001, ENADCDIV = 1	654	720	786	LSB
709	VBM()	VB Measurement	VB = 24 V, ADCC(2:0) = 010, ENADCDIV = 1	654	720	786	LSB
710	MDLM()	MDL Measurement	V(MD) - V(MR)  = 0.5 V, ADCC(2:0) = 011	413	455	497	LSB
711	MCM()			320	480	640	LSB
712	VRNM()	VRN Measurement	VRN = VBL = VB = 12 V, ADCC(2:0) = 101, ENADCDIV = 1	330	365	402	LSB
713	VRPM()	VRP Measurement	VRP = 24 V, ADCC(2:0) = 110, ENADCDIV = 1	658	724	790	LSB
714	ANINM()	ANIN Measurement	ANIN = 0.5 V, ADCC(2:0) = 111	409	451	493	LSB
Overt	emperature	1		1		1	II.
B01	Toff	Overtemperature Shutdown	Rising temperature	130		170	°C
B02	Ton	Overtemperature Release	Falling temperature	125		165	°C
B03	Thys	Hysteresis	Toff – Ton	3			°C
Temp	erature Mon	•	1	1			
C01	Trange	Temperature Measurement Range		-40		125	°C
C02	Tresol	Temperature Measurement Reso- lution			1		°C
C03	TEMP	Temperature Value Ranges	Tj = 125 °C Tj = -40 °C	160 0		190 15	LSB LSB
DCO	Output	1	, <del>.</del>				
	Isc()hi	DCO Output Current	V(VDD) = 33.5 V, V(DCO) < 1.4 V, RDCO = 0x3F	-175	-130	-85	μA

05/24 / V3 / MaH-IF / ichaus/ic-htg-laser-diode-driver

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#### ELECTRICAL CHARACTERISTICS

Operating Conditions: VB = VBL = 3 ... 24 V (relative to GND), Tj = -40 ... 125 °C unless otherwise stated

Item	Symbol	Parameter	Conditions				Unit
No.	-			Min.	Тур.	Max.	
D02	lleak		RDCO = 0x00 or NSTBY = lo, V(DCO) = 0 V(VDD)	-1		1	μA
D03	I(DCO)LSB	I(DCO) Resolution	V(DCO) < 1.4 V	1.3	2	2.7	μA
Oscilla	ator						
E01	F <sub>(osc)</sub>	Oscillator Frequency	NSTBY = hi	100	200	400	kHz
E02	T <sub>(CFGTIMO)</sub>	Configuration Mode Timeout	MODE(1:0) = 10, count of oscillator pulses		16400		Pulses
E03	tWDT	Watchdog Timeout	NSTBY = hi	20		120	μs

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#### **OPERATING REQUIREMENTS: SPI and I<sup>2</sup>C Interface**

tem	Symbol	Parameter	Conditions			Unit
No.				Min.	Max.	
SPI / I <sup>2</sup>	C Interface	e Timing				
1001	tsCCL	Setup Time: NCS/A1 hi $\rightarrow$ lo before SCLK lo $\rightarrow$ hi	INS = Io	20		ns
1002	tsDCL	Setup Time: MOSI/A0 stable before SCLK/SCL Io $\rightarrow$ hi	INS = Io	20		ns
1003	thDCL	Hold Time: MOSI/A0 stable after SCLK/SCL Io $\rightarrow$ hi	INS = Io	5		ns
1004	tCLH	Signal Duration SCLK/SCL hi	INS = lo INS = hi	5 1250		ns ns
1005	tCLL	Signal Duration SCLK/SCL lo	INS = lo INS = hi	5 1250		ns ns
1006	thCLC	Hold Time: NCS/A1 lo after SCLK/SCL $hi \rightarrow lo$	INS = Io	5		ns
1007	tCSH	Signal Duration NCS/A1 hi	INS = Io	20		ns
1008	tpCLD	Propagation Delay: MISO/SDA stable after SCLK/SCL hi $\rightarrow$ Io	V(VDD)>3 V, Cload = 10 pF, no external pull-up	0	30	ns
1009	f(SCLK)	SPI clock frequency			10	MHz
1010	f(SCL)	I <sup>2</sup> C clock frequency			400	kHz



Figure 1: SPI / I<sup>2</sup>C interface timing

05/24 / V3 / MaH-IF / ichaus/ic-htg-laser-diode-driver

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#### STANDBY

iC-HTG enters standby mode by setting pin NSTBY low. In standby mode with no current drained from pin VDD, the current consumption at VB is reduced to e.g.  $10 \,\mu A$  max. (cf. *Electrical Characteristics No. 002*) and the chip retains its RAM configuration.

for protection. As VDD is switched off in standby mode, it cannot be used to exit standby.

After wake-up (pin NSTBY's rising edge), the internal regulated supply voltage at VDD returns to its nominal value at a rate depending on the capacitor connected to pin VDD (cf. *Electrical Characteristics No. 504*).

In order to exit standby mode, pin NSTBY must be set to hi, e.g. to the supply voltage at VB. When connecting it to VB, a resistor of at least  $1 \ k\Omega$  in series is required

# More information about the start-up procedure on page 29.

#### **OPERATION MODE**

iC-HTG has two main modes: configuration mode and operation mode. The mode is set in register MODE(1:0).

DISC	Addr. 0x10; bit 3	R/W 1
Code	Function	
0	Channel can be enabled by pin EC	
1	Channel cannot be enabled by pin EC	

MODE(1:0)	Addr. 0x1C; bit 1:0	R/W 01
Code	Function	
00	Not allowed, signaled as memory error	
01	Chip set in operation mode (apply configuration, latch transparent)	
10	Chip set in configuration mode (hold previous configuration)	
11	Not allowed, signaled as memory error	

Table 5: Select configuration or operation mode

The internal parameters of iC-HTG are set in configuration mode via  $l^2C$  or SPI using a microcontroller. In this mode the configuration memory can be written and read back without changing the current configuration state of iC-HTG. Once the configuration is verified and accepted as valid, iC-HTG can be switched to operation mode and the new configuration will be activated. More information about configuration and operation modes and the serial communication interface on pages 27 and 18.

In operation mode, the driver is enabled by setting pin EC to hi. Setting register bit DISC to '1' disables the driver. If either pin EC is low or register bit DISC is high, the laser is disabled.

The iC-HTG can be configured for two control modes: laser-light power-control (APC) and laser current control (ACC). The control mode is selected by setting the EACC register. More about control modes is on page 13.

EACC	Addr. 0x10; bit 0	R/W 0
Code	Function	
0	APC mode enabled (laser power control)	
1	ACC mode enabled (laser current control)	

Table 7: Select APC or ACC

#### Laser enabling and error handling

Setting register bit DISC to '0' enables the laser channel.

The input pin INS needs to be high or low. With an open floating INS pin a corresponding internal error signal is generated (INSOPEN).

Internal INSOPEN error signal and status errors shown in Figure 2 disable the laser channel. Every change in the STATUS0 or STATUS1 registers is signaled at pin NCHK, unless the error event is masked by the corresponding error mask bit.

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Table 6: Disable channel



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Register	Address	Bits	Default	Description
INITRAM	0x00	0	R/O	RAM initialized
PDOVDD	0x00	1	R/O	Power down event at VDD
MEMERR	0x00	2	R/O	RAM memory validation error
OVT	0x00	3	R/O	Overtemperature event
PDOVBL	0x00	4	R/O	Power down event at VBL
OVC	0x00	5	R/O	Overcurrent
OSCERR	0x00	6	R/O	Oscillator error (watchdog set)
CFGTIMO	0x00	7	R/O	Configuration mode timeout event
MAPC	0x01	0	R/O	Channel current state read back
MONC	0x01	1	R/O	Channel enabled at least once (latched)
EC	0x01	2	R/O	EC pin current state read back
NMCOK	0x01	3	R/O	Current feedback status

#### Table 8: Status registers overview

are shown in Figure 2.

(Addr. 0x01)

STATUS1

DISC (Addr. 0x10 )

EC O

Pin

In order to enable the channel, the error events must be acknowledged. Acknowledging an error is accomplished by reading the corresponding STATUS register. After a power-on, PDOVDD and INITRAM errors will be set, therefore it is required to read the registers STATUS0 and STATUS1 after each power-on.

Exiting standby mode does not reset the RAM, but does set the PDOVDD status bit. Therefore STATUS0 must be read once after each standby to re-enable the laser channel.

In case of an overcurrent (OVC) or an overtemperature (OVT) event, the laser channel is disabled.

A memory error event (MEMERR) or a configuration timeout error event (CFGTIMO) also disables the laser

CONTROL MODES AND LASER DIODE/LED TYPES

iC-HTG features no integrated driver transistor. External power transistors (P-channel or N-channel) can be driven, connecting the gate of the transistor to pins VRP or VRN. Another possibility is to control a DC/DC converter directly, providing the best power efficiency.

iC-HTG can be configured for two control modes: laser power control (APC) and laser current control (ACC). The control mode is selected by setting bit EACC.

EACC	Addr. 0x10; bit 0	R/W 0
Code	Function	
0	APC mode enabled (laser power control)	
1	ACC mode enabled (laser current control)	

Table 9: Select APC or ACC

#### CI capacitor

For most applications a CI capacitor of at least 220 pF is recommended in order to ensure the stability of the control loop. The exact amount of capacitance needed depends on many factors such as PCB layout, output transistor, laser diode, and current range. The CI capacitor is used for APC and ACC. In APC configurations where the transistor gate is controlled by VRP, an additional capacitor (typ. 10 nF) from VRP to CI can further improve the control loop stability.

Figure 2: Laser control logic

channel. More information about the memory error is

on page 27. The conditions to enable the laser channel

Addr. 0x00)

STATUSC

NITRAN

#### ACC mode

In ACC mode, the laser current is controlled. ACC mode is selected by setting bit EACC to '1'. In this mode, an external shunt resistor (RMC) is used to monitor the laser diode current. The voltage drop across this shunt resistor serves as feedback to the control

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loop. To feed the current voltage drop to the control loop, the shunt resistor must be connected to the pins MCH and MCL. The voltage drop MCx = V(MCH) – V(MCL) needs to be positive. This voltage drop is internally amplified by a factor of 2, 5, 10 or 50. This factor can be selected using the register CGAIN(1:0). The resistor has to be chosen so that the value of the voltage drop multiplied by the amplification factor does not exceed the higher value of the reference generated with the 10-bit logarithmic D/A converter. This value is typically 1 V. More on this is on page 20.

CGAIN(1:0)	Addr. 0x15; bit 7:6	R/W 00
Code	Function	
00	Amplification set to x2	
01	Amplification set to x5	
10	Amplification set to x10	
11	Amplification set to x50	

Table 10: MCx voltage drop amplification

Depending on the output configuration and the position of RMC in the current path, the voltage between pins MCH and MCL will be in between 0 and 5 V or in the range from VBL -5 V to VBL. The MCx voltage range can be set with the register bit MCVR.

In ACC mode the register EPNNP is ignored.

Examples of connecting RMC using N-channel and P-channel transistors are shown in Figure 3.

By using the output transistor as a source follower like in Figure 3, the system shows increased stability and the Cl capacitor can be smaller. This is recommended for analog modulation with pin MOD. There are many other configurations possible depending on laser type, transistor, and voltage range. More information on page 34.

#### ACC mode monitoring the optical power

In ACC mode, the optical power can be measured using a laser with an integrated photodiode (N-type or P-type). Connecting the photodiode to pin MD, a proportional voltage to the photocurrent can be measured with the 10-bit linear A/D converter. Two examples of ACC mode using a laser with integrated photo diodes are shown in Figure 4.

MCVR	Addr. 0x13; bit 2	R/W 0
Code	Function	
0	MCx Voltage Range is 0 to 5 V	
1	MCx Voltage Range is VBL $-5$ V to VBL	

Table 11: MCx voltage range



Figure 3: Operation in ACC mode with N-channel or P-channel output transistor. EACC = 1, MCVR = 0 and MCVR = 1



Figure 4: Example of ACC monitoring the optical power EACC = 1. In the left setup MCVR = 0 and EPNNP = 0 while in the right setup, MCVR = 1 and EPNNP = 1

More examples of configurations for this application on page 34.

Depending on the type of laser, N or P, bit EPNNP has to be set to '0' or '1'.

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EPNNP	Addr. 0x13; bit 7	R/W 0
Code	Function	
0	N-type laser	
1	P-type laser	

Table 12: Enable P- or N- type laser

The monitor current is measured via its voltage drop across the internal 8-bit programmable logarithmic resistor PLR (more information about the PLR on page 19). If an external resistor shall be used, it must be connected to pins MD and MR and the internal resistor PLR must be disconnected by setting bit DISP to '1'.

DISP	Addr. 0x10; bit 2	R/W 0
Code	Function	
0	PLR enabled	
1	PLR disabled	

Table 13: Enable/disable PLR

To measure the optical power, register ADCC(2:0) has to be set to 0b011. Thus the internal voltage MDL =  $|V_{MD} - V_{MR}|$  will be selected as an input for the 10-bit A/D converter.

ADCC(2:0)	Addr. 0x10; bit 7:5	R/W 000
Code	Function	
000	ADC sourced by $V(VDD) \div 8 (3 5.5 V)$	
001	ADC sourced by V(VBL) ÷ 30 (3 24 V)	
010	ADC sourced by $V(VB) \div 30 (3 24 V)$	
011	ADC sourced by V(MDL) (0 1.1 V)	
100	ADC sourced by V(MC) (0 1.1 V)	
101	ADC sourced by V(VRN) ÷ 30 (0 24 V)	
110	ADC sourced by V(VRP) ÷ 30 (0 24 V)	
111	ADC sourced by V(ANIN) (0 1.1 V)	

Table 14: ADC source selection

#### APC mode

In APC mode, the optical laser power is controlled. APC mode is selected by setting bit EACC to '0'. In this mode, the monitor diode current is used as feedback in the laser power control loop. To introduce the monitor diode current in to the feedback control loop pins MR and MD are used. An internal, 8-bit programmable logarithmic monitor resistor (PLR) can be used in APC mode and is controlled by register RMD(7:0). It is also possible to use an external monitor resistor connected to pins MR and MD. If register bit DISP is '0', the PLR is present. If DISP is '1', the PLR is disabled and an external monitor resistor must be used. The PLR feature a wide logarithmic resistor range from 100  $\Omega$  to 500 k $\Omega$ in steps of typically 3.3%. This covers a wide range of monitor currents. More information about the PLR on page 19.

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For fine-tuning the optical power, the reference voltage is set with a 10-bit logarithmic D/A converter, which is configurable using register REF(9:0).

REF(9:8)	Addr. 0x13;	bit 1:0	R/W 0x000
REF(7:0)	Addr. 0x14;	bit 7:0	R/W 0x000
Code	Function		
0x000	Regulator reference	voltage se	t to minimum voltage
	Regulator reference Vref = $Vref_0(1 + \frac{\Delta V}{2})$	voltage se / <u>ref(%)</u> 100) <sup>n+1</sup> ,	t to n from 0 to 1023
0x3FF	Regulator reference	voltage set	to maximum voltage

Table 15: Channel regulator voltage reference

With EPNNP = 1 there is a signal level converter in the control loop, which references the values coming from the PLR to GND. This is necessary because the logarithmic D/A is referenced to GND. In addition this signal level converter adds a 1:2 ratio between the voltage at PLR and at the logarithmic D/A converter i.e. 1.1 V at the logarithmic D/A are 0.55 V at the PLR.

This converter has a voltage range that goes typically from Vref0 = 0.1 to Vrefmax = 1.1 V, allowing an operation resolution of typically  $\Delta$ Vref = 0.235%. More information on the logarithmic D/A converted on page 20. For calculating the minimum value for the monitor feedback current (Imon), Vref(0x00, max. value) (cf. *Electrical Characteristics No. 304*) and Rmda(RMDx = 0xFF, min. value) (cf. *Electrical Characteristics No. 201*) are used.

 $Imon(min) = \frac{Vref(0x000,max)}{n \times Rmda(RMDx = 0xFF,min)} = \frac{0.11}{350000} = 0.31 \,\mu A$ 

n = 2 for EPNNP = 1 n = 1 for EPNNP = 0

To calculate the maximum value of Imon, Vref(0x3FF, min. value) (cf. *Electrical Characteristics No. 304*) and Rmda(RMD(7:0) = 0x00, max. value) (cf. *Electrical Characteristics No. 201*) are used. The following formula is used to calculate Rmda(RMD(7:0) = 0x00, max. value):

 $Imon(max) = \frac{Vref(0x3FF,min)}{n \times Rmda(RMD = 0x00,max)} = \frac{1.00}{280} = 3.5 mA$ n = 2 for EPNNP = 1 n = 1 for EPNNP = 0

Any other Imon value can be calculated using the Rmd formula above. Due to its logarithmic characteristic, the steps between two consecutive values is kept typically within 3.3 % of the nominal value. This formula provide only an approximated value of the resistor. Because of the coupling factor between laser and photodiode and

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the parametric variation of the PLR, each system hast to be calibrated separately.

Thus, the internal voltage MC = V(MCH) - V(MCL) will be selected as an input for the 10-bit A/D converter.

iC-HTG is optimized for driving P-type and N-type laser diodes. Figure 5 shows two examples of driving Ptype and N-type laser diodes using APC mode. More examples of possible configurations on page 34.



Figure 5: APC with N-channel and P-channel output transistor using N-type and P-type laser diodes. EACC = 0, MCVR = 0, EPNNP = 0 for N-type lasers or EPNNP = 1 for P-type lasers

#### APC mode monitoring the laser current

In APC mode, there is the possibility to monitor the laser current using the 10-bit linear A/D converter and/or to use the overcurrent monitor function. More about overcurrent on page 17. To measure the optical power, a shunt resistor must be connected to pins MCH/MCL and the register ADCC(2:0) has to be set to 0b100.

ADCC(2:0)	Addr. 0x10; bit 7:5	R/W 000
Code	Function	
000	ADC sourced by $V(VDD) \div 8 (3 5.5 V)$	
001	ADC sourced by $V(VBL) \div 30 (3 24 V)$	
010	ADC sourced by $V(VB) \div 30 (3 24 V)$	
011	ADC sourced by V(MDL) (0 1.1 V)	
100	ADC sourced by V(MC) (0 1.1 V)	
101	ADC sourced by V(VRN) ÷ 30 (0 24 V)	
110	ADC sourced by $V(VRP) \div 30 (0 24 V)$	
111	ADC sourced by V(ANIN) (0 1.1 V)	

Table 16: ADC source selection



Figure 6: Example of APC monitoring the laser current. EACC = 0. Left: MCVR = 0, EPNNP = 0. Right: MCVR = 1, EPNNP = 1

More configuration examples on page 34.

#### Other functions

For some special applications (for example with low VB/VBL) it is useful to drive VRN up to VBL. In this case, the register bit VRNHR has to be set to '1'. The default and recommended value is setting the register bit VRNHR to '0'.

VRNHR	Addr. 0x13; bit 4	R/W 0
Code	Function	
0	VRN set from 0V to VBL-1V	
1	VRN set from 1V to VBL	

Table 17: VRN voltage range

Some applications might need an extra amplification stage after VRN/VRP with inversion of the polarity of the control. For such application, the register bit NSW is to be set to '0' and the polarity of the controller inverted.

NSW	Addr. 0x13; bit 6	R/W 1
Code	Function	
0	Inverted control mode (reference connected to negative input of regulator)	
1	Standard control mode (reference cor positive input of regulator )	nnected to

Table 18: CI regulator reference swap

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R/W 0

#### OVERCURRENT MONITOR

A programmable overcurrent shutdown can be set to protect the laser by disabling the channel. If the voltage drop at the external shunt resistor V(MCH) - V(MCL) is higher than the programmed value the overcurrent signal, OVC, is set and the laser channel is disabled. The maximum voltage drop at the shunt resistor can be programmed using the register ILIM(7:0).

An overcurrent event can be simulated using SOVC. If SOVC = 1 and the overcurrent detection is enabled (ILIM not set to 0x00), the corresponding overcurrent error bit OVC is set to 1, the error is signaled at NCHK, and the laser channel is disabled. The overcurrent error will remain forced until SOVC = 0.

Addr. 0x16; bit 5

		3000	Addi. Ux 16, Dil 5
Addr. 0x11; bit 7:0	R/W 0x00	Code	Function
Function		0	No overcurrent event is simulated.
Overcurrent detection disconnected.		1	Overcurrent event simulated.
Minimum value of V(MCH)-V(MCL) set value typ. (0.1V/CGAIN)	to minimum		Table 20: Simulate overcurrent
Maximum value of V(MCH)-V(MCL) set value typ. (1.1V/CGAIN)	t to maximum		

SOVC

Table 19: ILIM overcurrent register

#### WATCHDOG TIMER

ILIM(7:0)

Code

0x00

0x01

0xFF

The internal 200 kHz oscillator is monitored with a watchdog timer (WDT).

If the oscillator remains longer than the maximum time of tWDT (cf. Electrical Characteristics No. E03) without activity, an oscillator error is triggered. An oscillator error sets OSCERR error bit to '1'. The automatic offset compensation of the laser control (see page 13) requires the oscillator.

The state of OSCERR is signaled at pin NCHK. The signaling of OSCERR state can be masked with bit MOSCERR. Setting MOSCERR to '1' masks the oscillator error and in this case OSCERR is not signaled at NCHK.

It is possible to simulate an error of the oscillator using bit SOSCERR. If SOSCERR = 1, the oscillator error is forced. When OSCERR is set to '1', the error is signaled through NCHK depending on the state of MOSCERR.

OSCERR	Addr. 0x00; bit 6	R
Code	Function	
0	Oscillator functioning OK	
1	Watchdog timeout set on oscillator failure. Cleared on read	

Table 21: Oscillator watchdog

MOSCERR	Addr. 0x16; bit 0	R/W 0
Code	Function	
0	Oscillator error (watchdog) will be	signaled at NCHK
1	Oscillator error (watchdog) will not NCHK	be signaled at

Table 22: Oscillator watchdog error mask

SOSCERR	Addr. 0x16; bit 7	R/W 0
Code	Function	
0	No oscillator error simulated.	
1	Oscillator error simulated (watchdog tir	meout).

Table 23: Simulate oscillator error

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#### SERIAL COMMUNICATION INTERFACES

#### **Communication modes**

iC-HTG can be configured via a serial interface. It has two communication modes: SPI and I<sup>2</sup>C. Selection of the communication protocol is achieved using pin INS: INS = hi for I<sup>2</sup>C, INS = Io for SPI. If the pin INS is left open, NCHK will be pulled to 0.

#### SPI slave interface

The SPI slave interface is enabled by setting pin INS to lo and the interface uses pins NCS/A1, SCLK/SCL, MISO/SDA and MOSI/A0. The pin NCS/A1 is the chip select pin and must be set lo by the SPI master in order to start communication. The pins MISO/SDA and MOSI/A0 are the data communication lines and pin SCLK/SCL is the clock line generated by the SPI mas-

ter (e.g. a microcontroller). The SPI protocol frames are shown in Figure 7.

A communication frame consists of one address byte and at least one data byte. The bits 7:6 of the address byte are the opcode used for selecting a read operation (set to "10") or a write (set to "01") operation. The remaining 6 bits are used for register addressing.

It is possible to transmit several bytes consecutively if the NCS signal is not reset and SCLK/SCL keeps clocking, as is shown in Figure 7. The address is internally incremented after each transmitted byte. Once the address reaches the last register (0x3F), it is reset back to 0x00.



Figure 7: SPI commands

Action	b7	b6	b5	b4	b3	b2	b1	b0
Write to slave	1	0	1	0	ID	A1	A0	0
Read from slave	1	0	1	0	ID	A1	A0	1

used to set the remaining slave ID bits (see Tables 24 and 25).

Table 24: I<sup>2</sup>C write/read byte

#### I<sup>2</sup>C slave interface

The I<sup>2</sup>C slave interface is enabled by setting pin INS to hi and the interface uses pins NCS/A1, SCLK/SCL, MISO/SDA, ID, and MOSI/A0. The protocol frames are shown in Figure 8.

A communication frame consists of one slave address byte, one register address byte, and at least one data byte. The bits 7:1 of the slave address byte are build form the slave identification code (ID) and the address bit A1 and A0. Bit 0 is used to specify the data direction (RNW: 1 for read, 0 for write).

The four most significant bits are fixed by default to the value 0b1010. Pins MOSI/A0, NCS/A1, and ID are

Action	ID	A1	A0	Slave ID	Command byte
Write to slave 0	lo	lo	lo	0x50	0xA0
Read from slave 0	lo	lo	lo	0x50	0xA1
Write to slave 1	lo	lo	hi	0x51	0xA2
Read from slave 1	lo	lo	hi	0x51	0xA3
Write to slave 2	lo	hi	lo	0x52	0xA4
Read from slave 2	lo	hi	lo	0x52	0xA5
Write to slave 3	lo	hi	hi	0x53	0xA6
Read from slave 3	lo	hi	hi	0x53	0xA7
Write to slave 4	hi	lo	lo	0x54	0xA8
Read from slave 4	hi	lo	lo	0x54	0xA9
Write to slave 5	hi	lo	hi	0x55	0xAA
Read from slave 5	hi	lo	hi	0x55	0xAB
Write to slave 6	hi	hi	lo	0x56	0xAC
Read from slave 6	hi	hi	lo	0x56	0xAD
Write to slave 7	hi	hi	hi	0x57	0xAE
Read from slave 7	hi	hi	hi	0x57	0xAF

Table 25: I<sup>2</sup>C write/read command byte

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Figure 8: I<sup>2</sup>C commands

8-BIT INTERNAL PROGRAMMABLE LOGARITHMIC MONITOR RESISTORS

POWER CHANNE | | x1 MD | x2 DCO DCO

#### Figure 9: PLR internal node control

An internal 8-bit programmable logarithmic monitor resistor (PLR) is provided for the APC.

The PLR is used to control the optical power of the laser diode in APC mode or to measure a monitor photocurrent in ACC mode using the internal A/D converter. The resistor is connected to pins MR and MD using a force & sense switch structure. This ensures a low thermal dependency and a monotone dependence on the resistor with the register value RMD(7:0). Direct measuring of the internal resistor at pins MD/MR is not possible (see Figure 9).

RMD(7:0)	Addr. 0x12; bit 7:0	R/W 0xFF
Code	Function	
0x00	PLR set to the minimum resistance	
	PLR set to $Rmd = Rmd_0(1 + \frac{\Delta Rmd(\%)}{100})^{n+1}$ , n from	om 0 to 255
0xFF	PLR resistor set to the maximum res	

Table 26: MR-MD resistance selection

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The internal resistor value can be selected from 256 values, ranging from typ. Rmd0 = 100  $\Omega$  to over 407 k $\Omega$ , following logarithmic increments with a typical step width of  $\Delta$ Rmd = 3.3%. The resistors are configured with register RMD(7:0).

The following formula calculates the register RMD(7:0) in order to set the desired resistor value:

 $Rmd = Rmd_0(1 + \frac{\Delta Rmd(\%)}{100})^{n+1}, : n \in [0, 255],$ 

Where  $Rmd_0$  is the minimum resistor value (typically 100  $\Omega$ ),  $\Delta Rmd(\%)$  is the step between two consecutive resistor values (typically 3.3%) and *n* is the decimal value of register RMD(7:0).

Since the PLR has parametric variations and covers a wide range of resistors values, the given formula is only for simulation or information purposes. Each system needs to be individually calibrated. The recommended procedure is to enable the channel with a high value of RMD(7:0) and a medium value on register REF(9:0). While measuring the optical power, the PLR value is re-

#### **10-BIT LOGARITHMIC D/A CONVERTER**

The 10-bit logarithmic D/A converter is used for setting the regulator's voltage reference. The D/A converter is active in all operating modes. With a range from 0.1 to 1.1 V and the typical step width of  $\Delta$ Vref= 0.235% (maximum  $\Delta$ Vref= 1%). This ensures that with each LSB step there is a maximum change of 1% of the optical power.

The D/A converter is configured by REF(9:0). With REF(9:0) = 0x000 the D/A output value is set to 0.1 V and with REF(9:0) = 0x3FF to 1.1 V.

REF(9:8)	Addr. 0x13; bit 1:0	R/W 0x000
REF(7:0)	Addr. 0x14; bit 7:0	R/W 0x000
Code	Function	
0x000	Regulator reference voltage se	et to minimum voltage
	Regulator reference voltage s $Vref = Vref_0(1 + \frac{\Delta Vref(\%)}{100})^{n+1}$	et to n from 0 to 1023
0x3FF	Regulator reference voltage se	et to maximum voltage

Table 28: Channel regulator voltage reference

To calculate the D/A converter value for each REF(9:0) value, use the following equation.

$$V_{
m ref} = V_{
m ref0}(1 + rac{\Delta V_{
m ref}(\%)}{100})^{n+1}$$
 :  $n \in [0, 1023]$ 

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duced until the desired optical power is reached. Then using the register REF(9:0) you can make a more accurate selection of the optical power. For more information see page 13.

The PLR can be disabled via DISP.

DISP	Addr. 0x10; bit 2	R/W 0
Code	Function	
0	PLR enabled	
1	PLR disabled	

Table 27: Enable/disable PLR

In ACC mode the PLR is not part of the control circuit. Even though the PLR is not in the control circuit, it can be enabled (DISP = 0) in order to give feedback using the 10-bit A/D converter to monitor the optical power, if a monitor diode is connected.

Alternatively, an external monitor resistor can be used to measure the optical power, which requires DISP to be set to '1'.

Where  $Vref_0$  is the minimum value (typically 0.1 V),  $\Delta Vref(\%)$  is the step value (typically 0.235 %) and *n* is the decimal value of register REF.

Since the D/A has parametric variations, the given formula is only for simulation or information purposes. Each system has to be individually calibrated. The recommended procedure in APC mode is to enable the channel with a high value of RMD(7:0) and a medium value of REF(9:0). While measuring the optical power, reduce the PLR value until the desired optical power is reached. Then, using REF(9:0), you can make a more accurate selection of the optical power.

For ACC mode it is recommended to enable the laser with an appropriate value of REF(9:0). While measuring the optical power, increase the value of REF(9:0), until the desired optical power is reached. For more information see page 13.

#### Linear mode

The reference voltage for the control can be chosen from a 10 bit logarithmic DAC or a 10 bit Linear DAC with the LINLOG register. In the linear mode (LINLOG = 1), if the ADC is enabled, some noise might be present, since the reference for the control will be sampled and held during the ADC conversion cycle.

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# **iC-HTG** POWER CW LASER DIODE DRIVER

LINLOG	Addr. 0x16; bit bit 3	R/W 0
Code	Function	
0	Logarithmic 10 bit DAC selected	
1	Linear 10 bit DAC selected	

Table 29: Linear or Logarithmic reference selection

LINLOG also affects the overcurrent detection.

#### **10-BIT LINEAR A/D CONVERTER**

A 10-bit linear A/D converter is available for a variety of voltages that can be measured with different resolutions:

- V(VDD) up to 5.5 V with 8.6 mV resolution
- · V(VBL) up to 30 V with 32.3 mV resolution
- V(VB) up to 30 V with 32.3 mV resolution
- V(MDL) internal voltage up to 1.1 V with 1.075 mV resolution
- V(MC) internal voltage up to 1.1 V with 1.075 mV resolution
- V(VRN) up to 30 V with 32.3 mV resolution
- · V(VRP) up to 30 V with 32.3 mV resolution
- V(ANIN) up to 1.1 V with 1.075 mV resolution

As described in block diagram on Page 1, the voltages V(VDD), V(VBL), V(VB), V(VRN), V(VRP) and V(ANIN) are th PIN Voltage directly. V(MC) is proportional to the laser current value and is the voltage difference between pins MCH and MCL (V(MC) = V(MCH) – V(MCL)). The voltage V(MDL) is proportional to the optical laser power (monitor current) and the value is the absolute value of the difference between the pins MD and MR (V(MDL) = |V(MD) – V(MR)|).

The register ADCC(2:0) select the signal measured with the 10-bit A/D converter.

ADCC(2:0)	Addr. 0x10; bit 7:5	R/W 000
Code	Function	
000	ADC sourced by $V(VDD) \div 8 (3 5.5 V)$	
001	ADC sourced by $V(VBL) \div 30 (3 24 V)$	
010	ADC sourced by $V(VB) \div 30 (3 24 V)$	
011	ADC sourced by V(MDL) (0 1.1 V)	
100	ADC sourced by V(MC) (0 1.1 V)	
101	ADC sourced by V(VRN) ÷ 30 (0 24 V)	
110	ADC sourced by V(VRP) ÷ 30 (0 24 V)	
111	ADC sourced by V(ANIN) (0 1.1 V)	

Table 31: ADC source selection

LINLOG	OVC
0	Normal function
1	Disabled

Table 30: Overcurrent detection in Linear/Logarithmic Mode

DRDY	Addr. 0x07; bit bit 0	R
Code	Function	
0	No new ADC data since last read	
1	New ADC data available	

Table 32: ADC data ready

ENADCDIV	Addr. 0x16; bit bit 2	R/W 1
Code	Function	
0	ADC input voltage dividers disabled	
1	ADC input voltage dividers enabled	

Table 33: ADC voltage dividers enable

When enabled, the A/D converter is continuously acquiring the signal selected by register ADCC. The conversion time is 140  $\mu$ s. Changing the source with ADCC may require up to 500  $\mu$ s settling time of the sampling capacitors. Every time a conversion is finished, the bit DRDY is set. The MCU can poll the DRDY register and when a conversion is ready, read the correspondent data registers. The DRDY registers are clear when read and set back to one after a new conversion is ready.

#### Sampling input signals at a certain moment

To perform a conversion of an input signal at a certain moment (sampling), procedure can be as follows:

- Enable the input voltage dividers (ENADCDIV =

   Set ADCC to the desired input source and wait for the settling time (up to 500 μs).
- Disable ADC (ENAD = 0). This will cause DRDY to be cleared.
- 3. Enable ADC at the desired measurement moment to hold the input signal (ENAD = 1).
- Poll DRDY register until set to one and read ADC data.
- 5. Repeat from 2.

As the A/D converter is 10 bit long, the results are split into two byte wide separated registers; ADCh contains channel x ADC MSBs values while ADCI stores the LSBs. The A/D converter must be stopped before the

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# **iC-HTG** POWER CW LASER DIODE DRIVER

result can be read to prevent measurement change during MSB and LSB readout. The procedure is as follows:

- 1. Enable if not already the input voltage dividers (ENADCDIV set to 1), set ADCC to the desired input source with the ADC disabled (ENAD set to 0) and wait for the settling time (Item. 701, up to 500us)
- 2. Start ADC conversion (ENAD set to 1).
- 3. Wait for DRDY set to 1.
- 4. Stop the ADC (ENAD set to 0).
- 5. Read the ADC data.
- If ADC input source doesn't need to be changed, repeat from 2.

If the ADC converter is not to be used, the input voltage dividers can be disconnected to save some current (ENADCDIV set to 0).

The voltage corresponding to the measured digital value can be directly obtained using the following formula:

#### ANIN GENERAL PURPOSE IO PIN

 $V(VDD) = 8 * \frac{VFS}{1024} * ADCx$  $V(MDL, MC, ANIN) = \frac{VFS}{1024} * ADCx$ 

 $V(VBL, VB, VRP, VRN) = 30 * \frac{VFS}{1024} * ADCx$ 

VFS is the full scale voltage of the A/D converter (cf. *Electrical Characteristics No. 706*) typically 1.1 V. For a more precise measurement the A/D converter can be calibrated by measuring a known VB voltage and calculating the VFS.

ADC(9:8)	Addr. 0x03; bit 1:0	R
ADC(7:0)	Addr. 0x04; bit 7:0	R
0x000	ADC minimum value	
 0x3FF	ADC maximum value	

Table 34: ADC

The Pin ANIN is a general purpose IO Pin. Figure 10 describes the functionality of pin ANIN.



Figure 10: ANIN pin function description

With the pin ANIN an external analog voltage from 0 to 1.1 V can be digitized using the 10 bit linear A/D con-

verter. To this end register bit ANINO has to be set to 1 and the register ADCC(2:0) has to be set to value 0x07. For the digitizing higher voltages a resistor divider is recommended. An example of measuring voltages up to 24 V is shown in Figure 13.

ANIN can be used as a digital open collector output. As digital output an external pull-up resistor needs to be used. The maximum allowed voltage at pin ANIN is 5 V. With register bit ANINO the state of ANIN will be set.

ANINO	Addr. 0x1C; bit 2	R/W 1
Code	Function	
0	ANIN pin pulled low (open collector)	
1	ANIN pin set to high impedance	

#### Table 35: ANIN output state

RANIN	Addr. 0x01; bit 4	R
Code	Function	
0	ANIN pin is digital low at the precise reading moment.	
1	ANIN pin is digital high at the precise reading moment.	

Table 36: ANIN pin state

As digital TTL input the pin ANIN is mapped to status register bit RANIN.

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#### DC/DC CONVERTER OPTIMIZATION

iC-HTG provides a 6-bit configurable current source at pin DCO that can be used to trim the output voltage of a DC/DC converter. Current at DCO can be programmed with register RDCO(5:0). In standby mode, DCO current source is disconnected and set to high impedance. Possible application benefits with using DCO include:

- DC/DC step down operation: control at voltages lower than power supply
- DC/DC step up operation: control at voltages higher than power supply
- Efficiency enhancement

RDCO(5:0)	Addr. 0x15; bit 5:0	R/W 0x00
Code	Function	
0x00	No current	
0x3F	$130\mu\text{A}$ Typ (see spec point	D01)

Table 37: DCO current control

The proposed applications can be demonstrated with a standard DC/DC converter, e.g. TPS63060DSC from Texas Instruments. This converter allows an input voltage ranging from 2.5 to 12 V and offers an output voltage from 2.5 to 8 V. It is capable of delivering up to 2 A of current, depending on the output voltage. Figure 11 shows a possible configuration.



Figure 11: TPS63060 DC/DC converter from TI

#### DC/DC step down operation:

control at voltages lower than power supply The resistors R1 and R2 in the feedback path allow setting the desired output value Vout. The DC/DC converter drives Vout pin in order to yield 0.5 V at feedback pin FB. The DCO output signal from iC-HTG is connected to pin FB. Vout is controlled with the internal register RDCO(5:0) from iC-HTG.

The DCO current into FB controls the voltages of the divider R1 and R2 and Vout changes in order to maintain  $0.5\,V$  at the pin FB. When selecting R1 and R2, one needs to consider:

- Resistors values:  $R1 = R2(\frac{Vout}{Vfb} 1)$
- The current of the voltage divider should be high enough in comparison to the current from the pin DCO to offer acceptable resolution. The programmable current resolution of register RDCO(5:0) is 2  $\mu$ A.
- The DCO current into the voltage divider lowers the voltage Vout. Vout is 8 V when no current is present at DCO.

Choosing R1 = 100 k $\Omega,$  the value of R2 can be calculated to:

$$R2 = \frac{R1}{\frac{Vout}{V/b} - 1} = \frac{100k}{\frac{8V}{0.5V} - 1} = 6.7 \, k\Omega$$

With this configuration, the current through the voltage divider is  $75 \,\mu A$  at  $8 \,V$ . The resolution of each RDCO(5:0) step is then 200 mV.

The value in RDCO(5:0) register needed in order to have the desired output voltage can be calculated using the following formula:

$$\mathsf{RDCO} = \frac{ldco}{2\mu A} = \frac{lR2 - lR1}{2\mu A} = \frac{\frac{0.5V}{6.7k} - \frac{Vout - 0.5V}{100k}}{2\mu A}$$



Figure 12: Control of VB/VBL Supply using DCO

The resulting value varies slightly depending on the tolerances of the selected resistors and the DCO current. iC-HTG incorporates an internal 10-bit A/D converter.

05/24 / V3 / MaH-IF / ichaus/ic-htg-laser-diode-driver

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Selecting VBL or VB as input of this converter the supply voltage can be measured and the selected current at DCO can be changed in order to obtain the desired voltage at VBL/VB. Setting register ADCC(2:0) to 0b001 or 0b010, the supply voltages VBL or VB can be measured, respectively. The digitized value is the supply value divided by 30.

# DC/DC step up operation: control at voltages higher than power supply

A practical application of the present case is the control of blue lasers. This type of laser presents a forward voltage around 5 V, which demands a voltage of about 6 V for the anode of the laser diode (LDA). If the system is supplied from a 3 V LiPo battery, it is necessary to use a DC/DC in order to step up and drive the laser diode and driver with a sufficient voltage. Figure 12 shows this application. Jumper J1 can be set to 1-2 or 2-3 position.

Typically setting register RDCO(5:0) to 10 it delivers 20  $\mu A$  and 6 V, which are obtained at Vout.

#### Extension of system working voltage range

iC-HTG may be supplied with a voltage within the threshold values of 3 and 24 V. It is possible to control the DC/DC output in a voltage range of 2.5 to 24 V, if the DC/DC converter controlled by the DCO output signal is included in the system, as it is shown in Figure 12.

In Figure 12 both the laser and iC-HTG are supplied with output voltage Vout from DC/DC converter. Typically the register RDCO(5:0) is set to 23, which forces 48  $\mu$ A to be output to the voltage divider. A system voltage of 3.3 V is obtained at Vout.

#### Efficiency enhancement

If iC-HTG and the laser diode are supplied with the same power supply, the efficiency of the driver can be improved depending on the supplied voltage, the saturation voltage, and the laser diode forward voltage. The power dissipation of the driver transistor can be reduced if VBL is set through the DC/DC converter configured to deliver a voltage lower than the power supply as shown in Figure 13.

For this application the pin ANIN must be configured as an input by setting the register bit ANINO to 1. Using the resistors RA1 and RA2, the drain voltage at the Rev B1, Page 24/40

drive transistor is reduced by a factor of approximately 30. For more information about ANIN see page 22.



Figure 13: System efficiency enhancement

ANINO	Addr. 0x1C; bit 2	R/W 1
Code	Function	
0	ANIN pin pulled low (open collector)	
1	ANIN pin set to high impedance	

#### Table 38: ANIN output state

In this configuration, the voltage drop at the driver transistor can be measured and minimized by setting an appropriate supply at VBL. Some steps have to be done to optimize the power dissipation:

- Measure the voltage at pin VBL, setting the register ADCC(2:0) to 0b001. The measured voltage AD(VBL) is divided by a factor of 30.
- 2. Measure the voltage at pin ANIN, AD(ANIN).
- The voltage drop at the driver transistor is (AD(VBL) – AD(ANIN)) \* 30. By changing the DCO(6:0) register, the supply voltage at V(VBL) can be increased or decreased. ANIN should remain constant.
- Repeat steps 1 to 3 to achieve the desired voltage drop at the output transistor.

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#### ANALOG MODULATION

iC-HTG allows analog modulation of the output current at a frequency of up to 50 kHz. An external modulation voltage source (sinusoidal, triangular, etc.) must be provided and connected to pin MOD. The internal control loop forces the laser diode current to follow the modulation voltage signal. This feature is enabled by setting register bit ENAM high.

ENAM	Addr. 0x13; bit 3	R/W 0
Code	Function	
0	Analog modulation disabled	
1	Analog modulation enabled	

Table 39: Enable analog modulation



Figure 14: Recommended configuration for analog modulation using N-channel transistor. EACC = 1, MCVR = 0



Figure 15: Recommended configuration for analog modulation using P-channel transistor. EACC = 1, MCVR = 1

The maximum allowed modulation frequency is 50 kHz, but general performance depends on the external ca-

pacitor connected at CI, the value of the RMC, the current gain selected (CGAIN(1:0)), and the total gate capacity of the external transistor.

To ensure a higher stability, the configuration shown in Figure 15 is recommended (see Figure 20 left from Examples of configuration on page 34). CGAIN(1:0) must be kept as low as possible, increasing the value of the RMC if necessary. For 50 kHz modulation Figure 15 is recommended with values of CI from 100 to 300 pF.

#### **Setting Current Modulation**

The modulation current is set by 4 factors:

- The modulation amplitude at MOD (1.1 V max.)
- The digital-to-analog converter setpoint REF(9:0)
- · The external sense resistor RMC
- Current Channel gain CGAIN(1:0).

With the analog modulation VREF is no more a DC voltage for the regulator but a voltage divider for the V(MOD) voltage to downscale AC and DC voltages for the regulator. The V(MOD) voltage contains a DC voltage part and a AC voltage part to define the required operation point with the parameter set.



Figure 16: Signal path of the analog modulation

It is not recommended to use lower values that 100 mV for V(VREF). For lower voltages the accuracy of the control and the frequency response are not guaranteed. Therefore V(MOD) must be selected according to the REF(9:0) dividing factor to ensure V(VREF) higher or equal to 0.1 V.

For a first estimate of the values, the equation (1) and (2) can be used. In this equations REFx can be 1 to 1023 and CGAINx can take the values 2, 5, 10 and 50.

(1)  $V(RMC) = \frac{VMOD}{1023} \cdot \frac{REFx}{CGAINx}$ 

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(2)  $I(RMC) = \frac{VMOD}{1023} \cdot \frac{REF_X}{CGAIN_X} \cdot \frac{1}{RMC}$ 

With this equation the theoretical current value can be calculated. More accurate calculations can be made using the parameters 303 304 and 305 of the Electrical Characteristics and the equation (3) and (4).

(3)  $V(RMC) = \frac{VMOD}{11} \cdot \frac{V(REF)}{G(1)}$ 

(4)  $I(RMC) = \frac{VMOD}{11} \cdot \frac{V(REF)}{G(1)} \cdot \frac{1}{RMC}$ 



Figure 17: Example of modulation voltages

Due to the parameter variation is recommended to calibrate each circuit. The recommended procedure to set the current modulation values is:

- 1. Set the GAINx(1:0) value (0x00 is recommended).
- 2. Set a reference value of voltage in V(MOD). For example a low voltage or a DC voltage (VMODdc) in a sinus signal as shown in figure 17.
- 3. With a fixed voltage at V(MOD) (for example VMODdc) use REF(9:0) to set the desired

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V(RMC) (in this case V(RMCdc) for current laser (I(RMCdc)). You can use the internal AD-Converter to sense the voltage at RMC.

Note that using the equation the laser current I(RMCdc) is:

(5)  $I(RMCdc) = \frac{VMODdc}{1.1} \cdot \frac{V(REF)}{G(1)} \cdot \frac{1}{RMC}$ 

 With this setup the relationship between the voltage at V(MOD) and the referenced current is given by (7):

(6)  $I(RMChigh) = \frac{VMODhigh}{1.1} \cdot \frac{V(REF)}{G()} \cdot \frac{1}{RMC}$ 

(7)  $\frac{I(RMChigh)}{I(RMCdc)} = \frac{VMODhigh}{VMODdc}$ 

#### Analog Modulation in APC mode



Figure 18: Example of Analog Modulation ussing APC mode

It is possible to use analog modulation using an APC mode. In this case the stability of the system is more critical and hinger CI capacitors (> 1 nF) are recomended. This ist depending on laser diode, PCB and logarithmic resistor setting. Only a few kHz are recomended for the analog modulation in APC mode. An example of configuration using analog modulation in APC mode ist schown in Figure 18.

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#### **TEMPERATURE MONITOR AND PROTECTION**

iC-HTG includes an 8-bit temperature monitor that allows to measure the internal chip temperature going from -40 to 125 °C. The resolution is 1 °C/LSB.

TEMP(7:0)	Addr. 0x02; bit 7:0	R
Code	Function	
0x00	Minimum temperature	
0xFF	Maximum temperature	

Table 40: Chip temperature

Absolute read values may differ from one chip to another. An individual initial calibration of the temperature monitor is recommended. The TEMP register must be read at a known temperature. Using the resolution value of 1 °C/LSB, the internal temperature can be calculated.

The temperature monitor can be used to compensate temperature effects in the laser diode. The microcontroller can use a laser diode characteristic formula or a look-up table combined with the temperature value measured using TEMP register. The reference voltage can be configured accordingly in order to compensate for temperature effects.

iC-HTG is protected against overtemperature. If the internal temperature exceeds a safe value, an overtem-

CONFIGURATION MODE AND MEMORY INTEGRITY MONITOR

iC-HTG supports the interfaces SPI or I<sup>2</sup>C, which are selected by the INS pin. More information about the serial communication interface on page 18.

In the configuration mode the iC-HTG configuration can amended without affecting the configuration stored in the iC-HTG RAM. Only when switching back to the operation mode, the configuration is applied to the iC-HTG in an atomic operation (all at once).

Integrity monitoring is implemented by a duplication of the configuration registers into a validation page (see description below) where the registers are automatically copied with their inverted values. Every register bit is compared with its validation copy and, in case of inconsistency, a memory error is generated and the laser channel is switched off.

Atomic appliance is achieved by latching the configuration registers. This permits a full configuration (different perature error bit (OVT) is set to 1. If OVT = 1, the laser channel is disabled and the error event is signaled through pin NCHK. The error bit OVT is latched and can only be cleared by reading the status register.

The overtemperature threshold value can not be configured

OVT	Addr. 0x00; bit 3 R
Code	Function
0	No overtemperature event has occurred since last read
1	Overtemperature event has occurred. Cleared on read

Table 41: Overtemperature

It is possible to simulate an overtemperature event using the bit SOVT. Setting SOVT to 1, the overtemperature error flag OVT is set to 1. iC-HTG remains in the error state until SOVT is set back to 0.

SOVT	Addr. 0x16; bit 4	R/W 0
Code	Function	
0	No overtemperature event is simulated.	
1	Overtemperature event simulated.	

Table 42: Simulate overtemperature

registers) to be made prior to applying it to the laser channel.

The configuration mode is selected by setting the register MODE(1:0) to 10.

MODE(1:0)	Addr. 0x1C; bit 1:0	R/W 01
Code	Function	
00	Not allowed, signaled as memory error	
01	Chip set in operation mode (apply configuration, latch transparent)	
10	Chip set in configuration mode (hold previous configuration)	
11	Not allowed, signaled as memory error	

Table 43: Select configuration or operation mode

In Configuration mode the configuration memory (addr. 0x10 to 0x1F) can be written and read back to check a correct communication without changing the

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present configured operation state of the iC-HTG. In this mode, the memory integrity check is disabled.

iC-HTG will monitor the time elapsed in configuration mode and automatically switch the laser off, if it exceeds a configuration mode timeout. The time in configuration mode must be less than 40 ms to ensure that no configuration timeout occurs during configuration (cf. *Electrical Characteristics No. E02*). When writing the configuration is completed, iC-HTG is switched to **operating mode** by writing "01" into the MODE register (addr. 0x1C). In **operating mode** the configuration is applied to the iC-HTG and the memory integrity check activated. In this mode configuration registers can only be read (except MODE(1:0) register, which is always accessible). Figure 19 shows the interface to the memory structure.



Figure 19: Interface, RAM integrity monitoring, and configuration latching

#### **Register map description**

The register map consists of 64 addresses subdivided in three different pages:

- Read-only page, addr. 0x00 to 0x0F: iC-HTG status, ADC readout, temperature sensor readout and chip revision
- Configuration page (integrity monitored), read/write registers, addr. 0x10 to 0x1F
- Validation page, read/write registers, addr. 0x30 to 0x3F

#### Read-only registers with values or states

The read-only registers are sub-divided into status registers (addr. 0x00 to 0x01) and measurement registers and the chip revision register CHIPREV. Status registers are normally latched to 1 on events and cleared on read (see individual register description). Measurement registers are dual-port and can be accessed simultaneously with the measurements in progress. ADC (addr. 0x03 to 0x04) is a 10-bit register split into two 8-bit registers and must be accessed in block mode (automatic address increment) to ensure data does not change during the read.

#### Configuration page (integrity monitored)

The configuration page (addr. 0x10 to 0x1F) contains the registers that control the driver. Every write operation to any of the registers of this page will be internally duplicated to the correspondent register at the validation page. After the write operation, the correspondent validation register contains the inverted value of the configuration register.

#### Validation page

The validation page (addr. 0x30 to 0x3F) can be read or written normally. Only when a write procedure is made to any of the configuration registers, the correspondent validation pair will be written with the inverted value of the configuration register as well.

Both the configuration and validation pages are initialized during power-up. This event is signaled at the STATUS0 register (bit 0, INITRAM). In standby mode (NSTBY = Io) the RAM is not reset if any write command has been executed and therefore configuration and validation pages keep the stored information and INITRAM remains unset. Entering standby mode after power-up without any write command, the RAM will be initialized again and the INITRAM bit will be set to 1

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again. Any VDD power-down event signaled at the STA-TUS0 register outside the standby mode (NSTBY = hi) requires a RAM content check regardless of the state of the INITRAM bit to ensure data is not corrupted.

Possible start-up sequence:

- iC-HTG starts in operation mode with default configuration. INITRAM and PDOVDD error bits are set in STATUS0, DISC (addr. 0x10, bit 3) is set to 1.
- 2. Write MODE(1:0) = "10" register (addr. 0x1C) to enable the configuration mode.

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- 3. Configure the laser channel.
- 4. Read back to verify a correct data transfer.
- 5. Set the DISC bit to 0.
- Read the status registers (addr. 0x00, 0x01) to detect possible errors and validate status. At any error: read again to ensure that the error is valid.
- Write MODE(1:0) = "01" register (addr. 0x1C) to apply the configuration and enable the memory integrity check.
- 8. During operation: monitor the status registers, checking for errors. The pin NCHK signals any set status bit if not masked. This pin can be used to trigger an microcontroller interrupt line.

# REGISTER OVERVIEW

OVERV	/IEW								
Addr	Bit 7	Bit 6	Bit 5	Bit 4	Bit 3	Bit 2	Bit 1	Bit 0	
0x00 R	CFGTIMO	OSCERR	OVC	PDOVBL	OVT	MEMERR	PDOVDD	INITRAM	
0x01 R	0	0	0	RANIN	NMCOK	EC	MONC	MAPC	
0x02 R				TEM	P(7:0)	•			
0x03 R							ADC(9:8)		
0x04 R				ADC	(7:0)	•			
0x05 R	0	0	0	0	0	0	0	0	
0x06 R	0	0	0	0	0	0	0	0	
0x07 R	0	0	0	0	0	0	0	DRDY	
0x08 R				Not imp	emented				
	Not implemented								
0x0F R	CHIPREV								
0x10	ADCC(2:0)			1	DISC	DISP	ENAD	EACC	
0x11	ILIM(7:0)								
0x12	RMD(7:0)								
0x13	EPNNP	NSW	0	VRNHR	ENAM	MCVR	REF(9:8)		
0x14				REF	(7:0)				
0x15	CGAI	N(1:0)			RDC	O(5:0)			
0x16	SOSCERR		SOVC	SOVT	LINLOG	ENADCDIV	MMONC	MOSCERF	
0x17				Res	erved				
0x18				Not imp	emented				
0x19				Not imp	emented				
0x1A				Not imp	emented				
0x1B				Not imp	emented				
0x1C		I	Not implemente	ed		ANINO	MOD	E(1:0)	
Dx1D				Not imp	emented				
Dx1E				Reserved regi	ster. Set to zero				
0x1F			Res	erved register(Fa	ctory test). Set t	o zero			
0x20				Not imp	emented				
				Not imp	emented				

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OVERV	OVERVIEW									
Addr	Bit 7	Bit 6	Bit 5	Bit 4	Bit 3	Bit 2	Bit 1	Bit 0		
0x30	Validation content for 0x10, inverted									
0x31	Validation content for 0x11, inverted									
0x3F	Validation content for 0x1F, inverted									

#### Table 44: Register layout

#### PARAMETERS

Register	Address	Bits	Description
INITRAM	0x00	0	RAM initialized.
PDOVDD	0x00	1	Power-down event at VDD
MEMERR	0x00	2	RAM memory validation error
OVT	0x00	3	Overtemperature event
PDOVBL	0x00	4	Power-down event at VBL
OVC	0x00	5	Overcurrent
OSCERR	0x00	6	Oscillator error (watchdog set)
CFGTIMO	0x00	7	Configuration mode timeout event
MAPC	0x01	0	Channel state
MONC	0x01	1	Channel enabled at least once (latched)
EC	0x01	2	EC pin digital state
NMCOK	0x01	3	MCL, MCH voltage status
RANIN	0x01	4	ANIN pin digital state

Table 45: Status overview

Register	Address	Bits	Description
TEMP	0x02	7:0	Chip temperature measurement
ADCh	0x03	1:0	ADC 9:8 readout
ADCI	0x04	7:0	ADC 7:0 readout
DRDY	0x07	0	ADC data ready
CHIPREV	0x0F	7:0	Chip revision identification

#### Table 46: Measurement overview

#### Status

PDOVDD	Addr. 0x00; bit 1 F	۲ (
Code	Function	
0	VDD power down not occurred since last read	
1	VDD power down event has occurred. Cleared on read	

Table 48: VDD power down

INITRAM	Addr. 0x00; bit 0	R
Code	Function	
0	RAM not initialized since last read	
1	RAM initialized. Cleared on read	

#### Table 47: RAM initialization

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R

R

R

R

MEMERR	Addr. 0x00; bit 2	R
Code	Function	
0	RAM has not been changed since last validation	
1	RAM has changed and has not been validated	

Table 49: Memory validation

Code	Function
0	Channel has not been switched on since last read
1	Channel has been switched on at least once. Cleared on read

Table 56: Channel state history

Addr. 0x01; bit 2

EC pin is high at the precise reading moment. EC pin is low at the precise reading moment.

MCH-MCL voltage is OK for the selected laser type.

MCH-MCL voltage is not OK for the selected laser

Table 57: EC pin state

Addr. 0x01; bit 3

Table 58: MCH-MCL voltage status

Addr. 0x01; bit 4

ANIN pin is digital low at the precise reading

ANIN pin is digital high at the precise reading

Function

Function

type.

Function

moment.

moment.

Addr. 0x01; bit 1

MONC

> EC Code

0

1

NMCOK

Code

RANIN

Code

0

1

0

1

OVT	Addr. 0x00; bit 3	R
Code	Function	
0	No overtemperature event has occurred since la read	ast
1	Overtemperature event has occurred. Cleared read	on

Table 50: Overtemperature

PDOVBL	Addr. 0x00; bit 4	R
Code	Function	
0	VBL power down not occurred since last read	
1	VBL power down event has occurred. Cleared or read	n

Table 51: VBL power down

OVC	Addr. 0x00; bit 5 R	
Code	Function	
0	No overcurrent event has occurred since last read	
1	Overcurrent event has occurred. Cleared on read	

Table 52: Overcurrent

OSCERR	Addr. 0x00; bit 6	R
Code	Function	
0	Oscillator functioning OK	
1	Watchdog timeout set on oscillator failure. Cleared on read	

Table 53: Oscillator watchdog

CFGTIMO	Addr. 0x00; bit 7	R
Code	Function	
0	iC-HTG not in <i>configuration mode</i> or <i>timeout</i> did happened till now	not
1	iC-HTG in <i>configuration mode</i> and <i>timeout</i> happened. Laser switched off.	

Table 54: Configuration timeout

MAPC	Addr. 0x01; bit 0	R		DRDY	Addr. 0x07; bit bit 0	R
Code	Function			Code	Function	
0	Channel is off at the precise reading moment			0	No new ADC data since last read	
1	Channel is on at the precise reading moment			1	New ADC data available	
Table 55: Channel state					Table 61: ADC data ready	

#### TEMP(7:0) Addr. 0x02; bit 7:0 R Code Function 0x00 Minimum temperature 0xFF Maximum temperature

Table 59: ANIN pin state

Table 60: Chip temperature

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R/W 000

CHIPREV	Addr. 0x0F; bit 7:0	R
Code	Function	
16	iC-HTG 0	
17	iC-HTG 1	
18	iC-HTG Z	
19	iC-HTG Z1	
20	iC-HTG Y	
21	iC-HTG Y1	
22	iC-HTG X	
23	iC-HTG W	
24	iC-HTG W1	

Table 62: Chip revision

#### **Channel configuration registers**

101	ADC sourced by $V(V(N) \rightarrow 30(0$	24 V)	
110	ADC sourced by $V(VRP) \div 30 (0 24 V)$		
111	ADC sourced by V(ANIN) (0 1.	1 V)	
	Table 67: ADC source select	ction	
ILIM(7:0)	Addr. 0x11; bit 7:0	R/W 0x00	
Code	Function		
0x00	Overcurrent detection disconnect	ed.	
0x01	Minimum value of V(MCH)-V(MC value typ. (0.1V/CGAIN)	L) set to minimum	
0xFF	Maximum value of V(MCH)-V(MC value typ. (1.1V/CGAIN)	L) set to maximum	

Addr. 0x10; bit 7:5

ADC sourced by  $V(VDD) \div 8 (3 .. 5.5 V)$ 

ADC sourced by V(VBL) ÷ 30 (3 .. 24 V)

ADC sourced by  $V(VRN) \div 30 (0 ... 24 V)$ 

ADC sourced by  $V(VB) \div 30 (3 ... 24 V)$ 

ADC sourced by V(MDL) (0 .. 1.1 V)

ADC sourced by V(MC) (0 .. 1.1 V)

ADCC(2:0)

Code

000 001

010

011

100

101

R/W 0

R/W 0

R/W

Function

EACC	Addr. 0x10; bit 0	R/W 0
Code	Function	
0	APC mode enabled (laser power control)	
1	ACC mode enabled (laser current control)	

Table 63: Select APC or ACC

AD Converter enabled, source selected with ADCC

Addr. 0x10; bit 1

Table 64: Enable ADC

Addr. 0x10; bit 2

Table 65: Enable/disable PLR

Addr. 0x10; bit 3

Channel can be enabled by pin EC Channel cannot be enabled by pin EC

Table 66: Disable channel

AD Converter disabled

Function

Function

Function

PLR enabled

PLR disabled

#### Table 68: ILIM overcurrent register

RMD(7:0)	Addr. 0x12; bit 7:0	R/W 0xFF
Code	Function	
0x00	PLR set to the minimum resistance	
	PLR set to $Rmd = Rmd_0(1 + \frac{\Delta Rmd(\%)}{100})^{n+1}$ , n from	om 0 to 255
0xFF	PLR resistor set to the maximum res	

#### Table 69: MR-MD resistance selection

REF(9:8)	Addr. 0x13;	bit 1:0	R/W 0x000
REF(7:0)	Addr. 0x14;	bit 7:0	R/W 0x000
Code	Function		
0x000	Regulator reference	voltage se	t to minimum voltage
	Regulator reference voltage set to $Vref = Vref_0(1 + \frac{\Delta Vref(\%)}{100})^{n+1}$ , n from 0 to 1023		
0x3FF	Regulator reference	voltage se	t to maximum voltage

Table 70: Channel regulator voltage reference

MCVR	Addr. 0x13; bit 2	R/W 0
Code	Function	
0	MCx Voltage Range is 0 to 5 V	
1	MCx Voltage Range is VBL - 5 V to VBL	

#### Table 71: MCx voltage range

1	ENAM	Addr. 0x13; bit 3	R/W 0
	Code	Function	
	0	Analog modulation disabled	
	1	Analog modulation enabled	

Table 72: Enable analog modulation

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ENAD

Code

DISP

Code

DISC

Code

0

1

0 1

0



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R/W 0

NSW	Addr. 0x13; bit 6	R/W 1
Code	Function	
0	Inverted control mode (reference connected negative input of regulator)	d to
1	Standard control mode (reference connecte positive input of regulator )	ed to

e input of regulator )	

#### Table 73: CI regulator reference swap

EPNNP	Addr. 0x13; bit 7	R/W 0
Code	Function	
0	N-type laser	
1	P-type laser	

#### Table 74: Enable P- or N- type laser

RDCO(5:0)	Addr. 0x15; bit 5:0	R/W 0x00
Code	Function	
0x00	No current	
0x3F	130 µA Typ (see spec point D01)	

Table 75: DCO current control

CGAIN(1:0)	Addr. 0x15; bit 7:6	R/W 00
Code	Function	
00	Amplification set to x2	
01	Amplification set to x5	
10	implification set to x10	
11	Amplification set to x50	

#### Table 76: MCx voltage drop amplification

MOSCERR	Addr. 0x16; bit 0	R/W 0
Code	Function	
0	Oscillator error (watchdog) will be signaled at NCHK	
1	Oscillator error (watchdog) will not be signaled at NCHK	

Table 77: Oscillator watchdog error mask

MMONC	Addr. 0x16; bit 1	R/W 1
Code	Function	
0	Enable Channel will be signaled at NCHK	
1	Enable Channel will not be signaled at NCI	нк

#### Table 78: Enable Channel (ENCH) monitor mask

SOVT	Addr. 0x16; bit 4	R/W 0
Code	Function	
0	No overtemperature event is simulated.	
1	Overtemperature event simulated.	

Table 79: Simulate overtemperature

#### 1 Overcurrent event simulated. Table 80: Simulate overcurrent

Addr. 0x16; bit 5

No overcurrent event is simulated.

Function

SOVC

Code

0

SOSCERR	Addr. 0x16; bit 7	R/W 0
Code	Function	
0	No oscillator error simulated.	
1	Oscillator error simulated (watchdog timed	out).

Table 81: Simulate oscillator error

ENADCDIV	Addr. 0x16; bit bit 2	R/W 1
Code	Function	
0	ADC input voltage dividers disabled	
1	ADC input voltage dividers enabled	

Table 82: ADC voltage dividers enable

Addr. 0x16; bit bit 3	R/W 0
Function	
Logarithmic 10 bit DAC selected	
Linear 10 bit DAC selected	
	Function Logarithmic 10 bit DAC selected

Table 83: Linear or Logarithmic reference selection

MODE(1:0)	Addr. 0x1C; bit 1:0	R/W 01
Code	Function	
00	Not allowed, signaled as memory error	
01	Chip set in operation mode (apply configuration, latch transparent)	
10	Chip set in configuration mode (hold previous configuration)	
11	Not allowed, signaled as memory error	

Table 84: Select configuration or operation mode

ANINO	Addr. 0x1C; bit 2	R/W 1
Code	Function	
0	ANIN pin pulled low (open collector)	
1	ANIN pin set to high impedance	

#### Table 85: ANIN output state

VRNHR	Addr. 0x13; bit 4	R/W 0
Code	Function	
0	VRN set from 0V to VBL-1V	
1	VRN set from 1V to VBL	

Table 86: VRN voltage range

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# iC-HTG POWER CW LASER DIODE DRIVER Rev B1, Page 34/40 **EXAMPLES OF CONFIGURATION** ACC mode Examples of ACC mode using P-channel transistor, Figures 20 and 21. (Recommended) Figure 20: Working in ACC mode with P-channel output transistor as follower. (Recommended) EACC MCVR EPNNP 1 1 Table 87: Register for Figure 20 output transistor. Figure 21: Working in ACC mode with P-channel output transistor EACC MCVR EPNNP 0 1 Table 88: Register for Figure 21

Examples of ACC Mode using N-channel transistor, Figures 22 and 23.

Figure 22: Working in ACC mode with N-channel output transistor as follower.

EACC	MCVR	EPNNP
1	0	-

Table 89: Register for Figure 22



Figure 23: Working in ACC mode with N-channel

EACC	MCVR	EPNNP
1	1	-

Table 90: Register for Figure 23

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#### APC mode

Examples of APC mode using N-channel transistor, Figures 24 and 25.

Examples of APC mode using P-channel transistor, Fig-

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Figure 24: Working with N-channel output transistor and N-type laser diode.



Table 91: Register for Figure 24



Figure 25: Working with N-channel output transistor and P-type laser diode.

EACC	MCVR	EPNNP
0	0	1

Table 92: Register for Figure 25



ures 26 and 27.

Figure 26: Working with P-channel output transistor and N-type laser diode.

EACC	MCVR	EPNNP
0	0	0

Table 93: Register for Figure 26



Figure 27: Working with P-channel output transistor and P-type laser diode.

EACC	MCVR	EPNNP
0	0	1

Table 94: Register for Figure 27

Note that in Figures 25 right and 27 right the VBL voltage is limited to 5 V.

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APC mode with current monitor or ACC mode with optical power monitor



#### Figure 28: iC-HTG with N-channel output transistor and N-type laser diode.

Register	Figure 28.a	Figure 28.b	Figure 28.c	Figure 28.d	EACC	ADCC
MCVR	1	1	0	0	1	011
EPNNP	0	0	0	0	0	100



Table 95: Configuration register for Figure 28

Figure 29: iC-HTG with N-channel output transistor and P-type laser diode

Register	Figure 29.a	Figure 29.b	Figure 29.c	Figure 29.d	EACC	ADCC
MCVR	1	1	0	0	1	011
EPNNP	1	1	1	1	0	100

Table 96: Configuration register for Figure 29

Note that in Figures 29.b and 29.c the VBL voltage is limited to 5 V.

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1 1	0	0	1	
0 0	0	0	0	

Laser Diodes



# **iC-HTG** POWER CW LASER DIODE DRIVER



Figure 30: iC-HTG with P-channel output transistor and N-type laser diode.

Register	Figure 30.a	Figure 30.b	Figure 30.c	Figure 30.d	EACC	ADCC
MCVR	1	1	0	0	1	011
EPNNP	0	0	0	0	0	100



Table 97: Configuration register for Figure 30

Figure 31: iC-HTG with P-channel output transistor and P-type laser diode

Register	Figure 31.a	Figure 31.b	Figure 31.c	Figure 31.d	EACC	ADCC
MCVR	0	0	1	1	1	011
EPNNP	1	1	1	1	0	100

Table 98: Configuration register for Figure 31

Note that in Figures 31.b and 31.d the VBL voltage is limited to 5 V.

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#### **DESIGN REVIEW: Notes On Chip Functions**

#### IC-HTG 7, 71

IC-HIGZ, Z	1	
No.	Function, Parameter/Code	Description and Application Notes
1	NEBUF	For iC-HTG chip releases Z and Z1 it is <b>NOT</b> recommended to use NEBUF = 0. Otherwise, proper operation of the control loop can not be guaranteed for all conditions. The parameter NEBUF does not exist anymore with iC-HTG chip release Y or higher.
2	CHIPREV	For iC-HTG chip releases see Table 62.

Table 99: Notes on chip functions regarding iC-HTG chip release Z and Z1

iC-HTG Y, Y	iC-HTG Y, Y1				
No.	Function, Parameter/Code	Description and Application Notes			
1	VRNHR	Voltage output range selection for VRN. More information on Table 86 and page 16.			
2	CHIPREV	For iC-HTG chip releases see Table 62.			

Table 100: Notes on chip functions regarding iC-HTG chip release Y and Y1

iC-HTG X		
No.	Function, Parameter/Code	Description and Application Notes
1	DRDY	Data Ready Status Register for A/D Synchronisation. More information on page 21.
2	ENADCDIV	Save current bit if voltage dividers are not used in AD. More information on page 21
3	LINLOG	Logarithmic DA converter can be set as linear one. More information on page 21
4	ESD	Internal ESD Protection under 500 V
5	CHIPREV	For iC-HTG chip releases see Table 62.
6	Permissible Supply Voltage at VB, Electrical Characteristics No. 001	VB = 10 V max.

Table 101: Notes on chip functions regarding iC-HTG chip release X

IC-HTG W1					
No.	Function, Parameter/Code	Description and Application Notes			
1	CHIPREV	For iC-HTG chip releases see Table 62.			

Table 102: Notes on chip functions regarding iC-HTG chip release W1

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#### **REVISION HISTORY**

Rel.	Rel. Date <sup>†</sup>	Chapter	Modification	Page
A1	2017-11-24		Initial release	
Rel.	Rel. Date <sup>†</sup>	Chapter	Modification	Page
B1	2020-10-01	DESCRIPTION	Poti max. value changed form 500 to 407 kΩ	2
		ABSOLUTE MAXIMUM RATINGS	G005, G007: pin EC added	6
		ELECTRICAL CHARACTERISTICS	Operating Conditions: VB = VBL = 3 24 V (relative to GND), Tj = -40 125 °C unless otherwise stated	7–10
		ELECTRICAL CHARACTERISTICS	Specification Updated at Item No. 003, 006, 008, 012, 103, 303, 502 added and inserted, 304 306, 107 110, 402, 605, 609, 711, C03, D02 and E02	7–10
		STANDBY	Additional series resistor when connecitng NSTY to VB	12
		OPERATION MODE	Renamed PDVDD => PDOVDD	13
		CONTROL MODES AND LASER DIODE/LED TYPES	New function Register VRNHR described	16
		8-BIT INTERNAL PROGRAMMABLE LOGARITHMIC MONITOR RESISTORS	Poti max. value changed form 500 to 407 $k\Omega$	20
		10-BIT LOGARITHMIC D/A CONVERTER	New Linear Reference Mode described (introduced in HTG_X version)	20
		10-BIT LINEAR A/D CONVERTER	New register DRDY and ANADCDIV described. New method for synchronisation of the AD described. (introduced in HTG_X version)	21
		10-BIT LINEAR A/D CONVERTER	Readout advise added	22
		REGISTER OVERVIEW	Updated	29
		DESIGN REVIEW: Notes On Chip Functions	Chapters added	41

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<sup>†</sup> Release Date format: YYYY-MM-DD

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#### ORDERING INFORMATION

Туре	Package	Order Designation
iC-HTG	QFN24 4 mm x 4 mm	iC-HTG QFN24-4x4
Evaluation Board	100 mm x 80 mm eval board	iC-HTG EVAL HTG1D

Please send your purchase orders to our order handling team.

For technical support, information about prices and terms of delivery please contact us.

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